You should delete the nylon screws/standoffs and/or the bump on the as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.
Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).
Update the Label Text in the Label Table as needed for each Assembly Variant.
You should delete this note too.

PCB Number: TIDA-00929
PCB Rev: E1
PCB LOGO
Texas Instruments
PCB LOGO
PCB LOGO
PCB LOGO

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This Assembly Note is for PCB labels only.

These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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